

BU810

THERMAL DATA

$R_{thj-case}$	Thermal Resistance Junction-case	Max	1.66	$^{\circ}C/W$
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ELECTRICAL CHARACTERISTICS ($T_{case} = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current ($V_{BE} = 0$)	$V_{CE} = 600 V$			200	μA
I_{CEO}	Collector Cut-off Current ($I_B = 0$)	$V_{CE} = 400 V$			1	mA
I_{EBO}^*	Emitter Cut-off Current ($I_C = 0$)	$V_{EB} = 5 V$			150	mA
$V_{CEO(sus)}^*$	Collector-Emitter Sustaining Voltage	$I_C = 0.1 A$	400			V
$V_{CE(sat)}^*$	Collector-Emitter Saturation Voltage	$I_C = 2 A$ $I_B = 20 mA$			2	V
		$I_C = 4 A$ $I_B = 200 mA$			2.5	V
		$I_C = 7 A$ $I_B = 0.7 A$			3	V
$V_{BE(sat)}^*$	Base-Emitter Saturation Voltage	$I_C = 2 A$ $I_B = 20 mA$			2.2	V
		$I_C = 4 A$ $I_B = 200 mA$			3	V
V_F	Diode Forward Voltage	$I_F = 7 A$			3	V

RESISTIVE SWITCHING TIMES

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{on}	Turn-on Time	$V_{Clamp} = 250V$ $I_C = 2A$ $I_{B1} = 20mA$ $V_{BE(off)} = -5 V$			0.6	μs
t_s	Storage Time				1.5	μs
t_f	Fall Time				0.5	μs

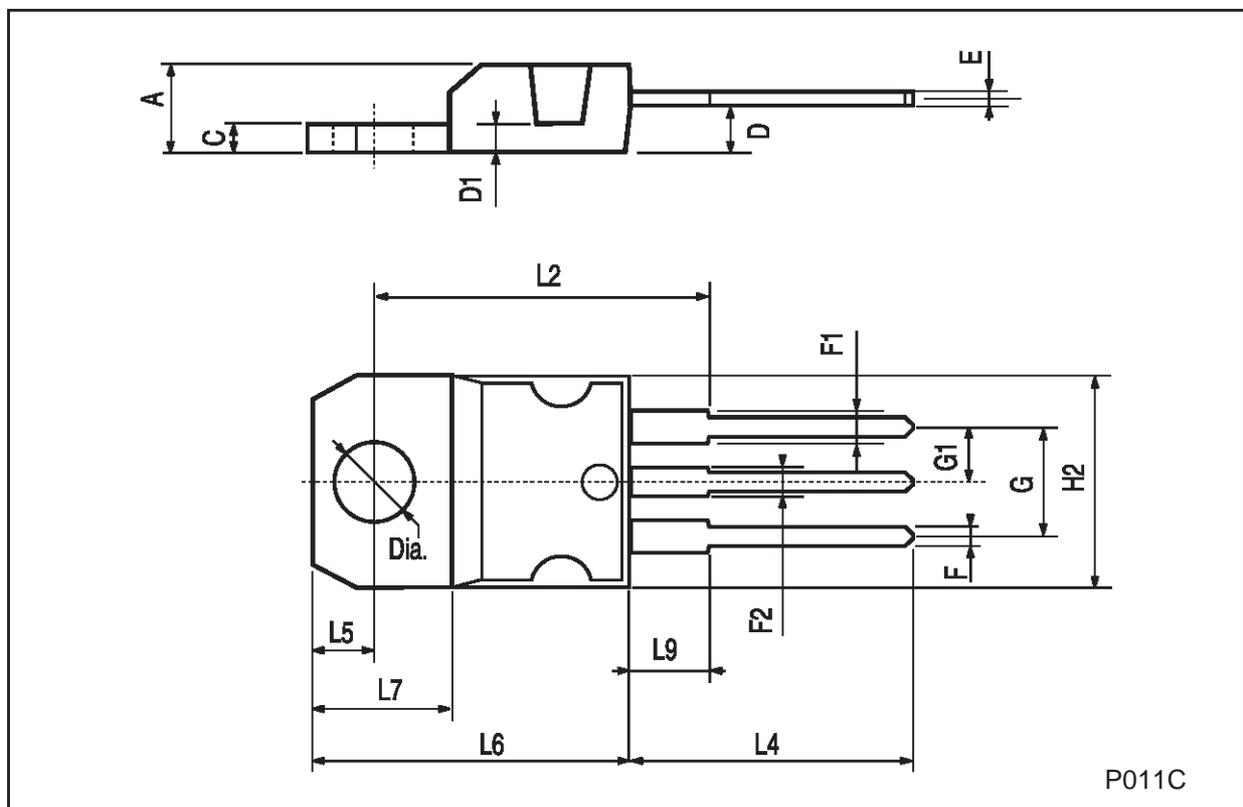
INDUCTIVE SWITCHING TIMES

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_s	Storage Time	$V_{Clamp} = 250V$ $I_C = 2A$ $I_{B1} = 20mA$ $V_{BE(off)} = -5 V$ $L = 500\mu H$			1.5	μs
t_f	Fall Time				0.4	μs
t_s	Storage Time	$V_{Clamp} = 250V$ $I_C = 7A$ $I_{B1} = 0.7A$ $V_{BE(off)} = -5 V$ $L = 500\mu H$			1.5	μs
t_f	Fall Time				0.4	μs

* Pulsed : Pulse duration = 300 μs , duty cycle = 2%

TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



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